UNCONTROLLED DOCUMENT

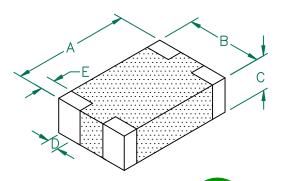
CM1812X330R-10

PHYSICAL DIMENSIONS:

A 4.57 [.180] ± 0.25 [.010] B 3.05 [.120] ± 0.25 [.010] C 1.60 [.063] ± 0.25 [.010]

D 1.14 [.045] ± 0.13 [.005]

E 0.58 [.023] ± 0.18 [.007]



NOTES: UNLESS OTHERWISE SPECIFIED

Nominal (Ref)

COMMON MODE Z COMMON MODE Z @ 100 MHz(\(\Omega\)) | @ 500 MHz(\(\Omega\))

33

25

41

Nominal (Ref)

Minimum

Maximum

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 13" REELS, 2500 PCS/REEL.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.

COMMON MODE ELECTRICAL CHARACTERISTICS:

CONTINOUS Rated

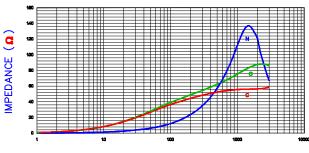
Current

10,000 mA

0.003

- 3. U.S. PATENT 6,288,626 SHOULD APPEAR ON THE LABEL OF EACH REEL OF PACKAGED PARTS.
- 4. MINIMUM LINE TO LINE RESISTANCE $1M\Omega$.
- 5. TERMINATION FINISH IS 100% TIN.

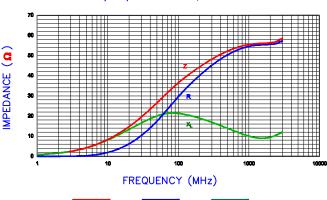
Z vs. FREQUENCY (C,N,O)



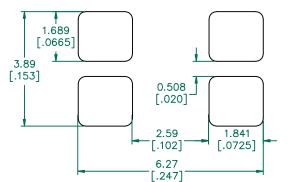
FREQUENCY (MHz)

Common





Compliant



LAND PATTERNS FOR REFLOW SOLDERING

DURING AND AFTER SOLDERING OPERATION SOLDER MUST NOT BE ALLOWED TO BRIDGE CONTACTS. CONTACT SEPARATION MUST BE

ORIGINAL DRAFT

DESCRIPTION

RECOMMENDED SOLDERING CONDITIONS REFLOW SOLDERING PRE-HEATING SOLDERING NATURAL COOLING 130 [266] 130 [266]

DIMENSIONS ARE IN mm [INCHES].

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100 SECONDS

UPDATE COMPANY LOGO 05/16/07 JRK CM1812X330R-CHG MIN LINE TO LINE RESISTANCE 09/28/05 JRK DATE: 03/03/05

03/02/05 JRK

DATE INT

ROJECT/PART NUMBER: REV PART TYPE: CO-FIRE JI

ATE: 03/02/05 SCALE: NTS SHEET: CM1812X330R-10-C CM1812 2 of 2

5 - 10 SECONDS

60 SECONDS

AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 4194